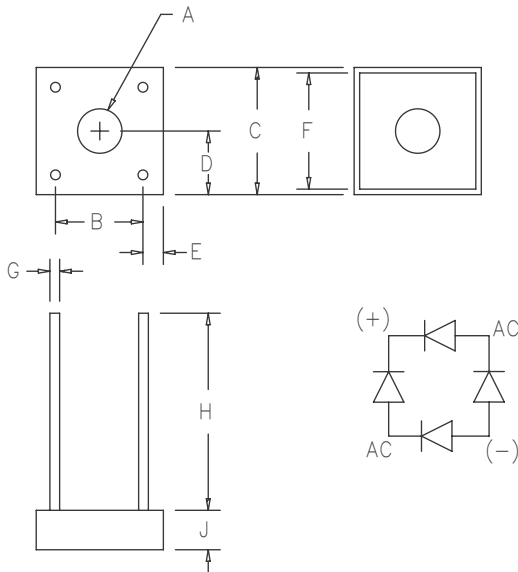


Bridge Rectifiers

VJ248M — VJ1048M



| Dim. | Inches | | Millimeter | | Notes |
|------|----------|---------|------------|---------|-------|
| | Minimum | Maximum | Minimum | Maximum | |
| A | .137 | .167 | 3.84 | 2.21 | Dia. |
| B | .411 | .441 | 10.44 | 11.20 | |
| C | .600 | .620 | --- | --- | |
| D | .295 | .310 | --- | --- | |
| E | .076 | .096 | --- | --- | |
| F | .545 | .555 | 13.85 | 14.10 | |
| G | .076 | .096 | .970 | 1.07 | |
| H | 1.0 Min. | | 25.40 Min. | | |
| J | .195 | .215 | 4.95 | 5.46 | |

| Microsemi Catalog Number | Peak Reverse Voltage |
|--------------------------|----------------------|
| VJ248M | 200V |
| VJ448M | 400V |
| VJ648M | 600V |
| VJ848M | 800V |
| VJ1048M | 1000V |

- 10 Amps DC Output
- 100 Amp Surge Current
- V_{RRM} to 1000V
- 2000V Isolation
- Glass Passivated Die
- ROHS Compliant

| Electrical Characteristics | | |
|--|--------------------|-------------------------------------|
| DC current output | I_o 10 Amps | $T_C = 95^\circ C$ |
| Maximum surge current | I_{FSM} 100 Amps | 8.3ms, half sine |
| Max. I^2t for fusing | I^2t 41 A^2s | |
| Max. peak forward voltage per leg | V_{FM} 1.3 Volts | $I_{FM} = 1.0A; T_J = 25^\circ C^*$ |
| Max. peak reverse current per leg | I_{RM} 5 μA | $V_{RRM}, T_J = 25^\circ C$ |
| *Pulse test: Pulse width 300 μsec , Duty cycle 2% | | |

| Thermal and Mechanical Characteristics | | |
|--|-----------------|---------------------------------|
| Storage temperature range | T_{STG} | $-55^\circ C$ to $175^\circ C$ |
| Operating junction temp range | T_J | $-55^\circ C$ to $175^\circ C$ |
| Maximum thermal resistance | $R_{\theta JC}$ | 3 $^\circ C/W$ Junction to case |
| Mounting torque | | 12–15 inch pounds (#6 screw) |
| Weight | | .14 ounces (4.5 grams) typical |

VJ248M — VJ1048M

Figure 1
Typical Forward Characteristics — Per Leg

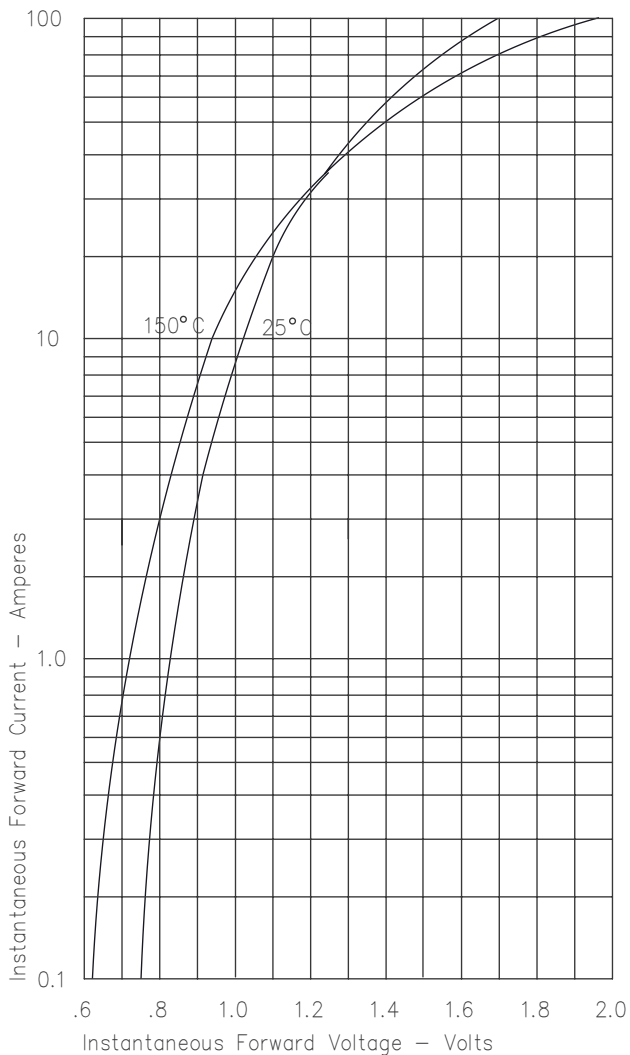


Figure 3
Forward Current Derating — Per Leg

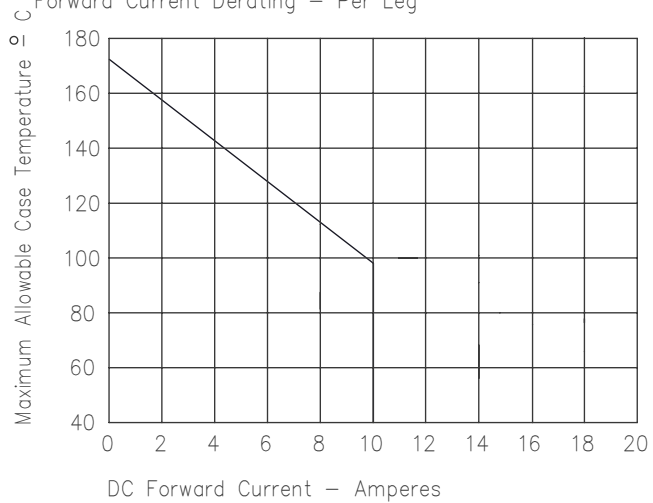
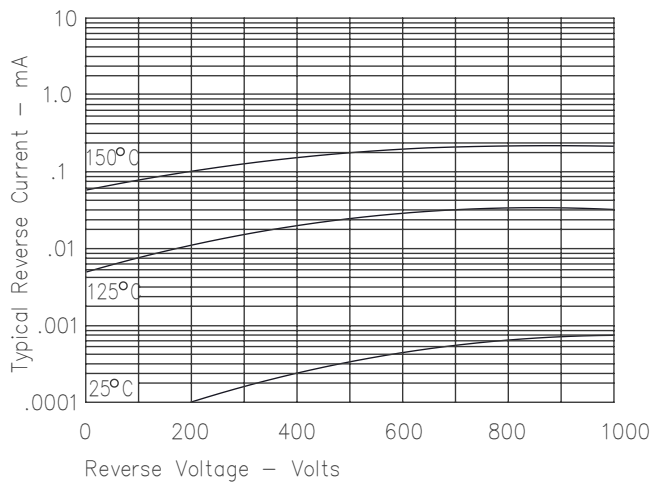


Figure 2
Typical Reverse Characteristics — Per Leg



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